TQS - COMPANY PROPRIETARY INFORMATION	SPEC. NO:	DAT.CLY2
	REV:	В
SPEC TITLE: CLY2 DATASHEET	PAGE	1 OF 9

	REVISION HISTORY							
REV	DATE	ECN#	DESCRIPTION OF CHANGE	Internal Web Site?	External Web Site?			
A	10-16-03	22355	New release of CLY2 datasheet (formerly DAT.057 rev D) ; also replaced S-PAR & noise match tables, p. 6 & 7 ; replaced output charasteristics tables, p. 5 ; by R. Hamilton.	No	Yes			
В	12-06-04	27162	Updated to reflect Ver 1.8, March 4, 2004; revised package name to MW6, p.1; deleted 5V electrical characteristics, p. 7; by M. Rensfeldt	No	Yes			
MOM								
INI2 M			CONTROLLED DISTRIBUTION: (	)3				

NOTE: UNLESS STAMPED WITH A RED "CONTROLLED " STAMP AND STATION NUMBER, THIS IS AN UNCONTROLLED COPY AND WILL NOT BE UPDATED CONFIRM THAT IT IS CURRENT BEFORE USING.



## **High-Power Packaged GaAs FET**

### **Description:**

The CLY2 is a high-breakdown voltage GaAs FET designed for PA driver applications in the 400 MHz to 3 GHz frequency range. It is ideal for portable PA applications in mobile phones and portable WLAN transceivers due to its easy matching and excellent linearity. The CLY2 exhibits +23.5 dBm output power with +3V Vds at 1.8 GHz with an associated gain of 14.5 dB. Power added efficiencies to 55% are achievable.

### **Features:**

- For frequencies up to 3 GHz
- Wide operating voltage range: 2 to 6 V
- $P_{OUT}$  23.5 dBm typical at V<sub>D</sub>=3V, f=1.8GHz
- High efficiency: better than 55 %
- Nfmin 0.79 dB typical at 900 MHz
- Low Cost

### **Applications:**

- Power Amplifiers for WLAN transceivers
- Driver Amplifiers for WLAN or mobile phone basestations
- Low Noise Amplifier for basestations and antenna amplifiers

## Package Outline, MW6:



Pin Configuration: 1 & 6: Gate 2 & 5: Source 3 & 4: Drain

## **Maximum Ratings:**

Parameter	Symbol	Values	Unit
Drain-source voltage	VDS	9	V
Drain-gate voltage	VDG	12	V
Gate-source voltage	VGS	-6	V
Drain current	۱ <sub>D</sub>	600	mA
Channel temperature	⊤Ch	150	°C
Storage temperature	⊤ <sub>stg</sub>	-55+150	°C
Total power dissipation (T <sub>s</sub> $\leq$ 50 °C) <sup>1)</sup>	P <sub>tot</sub>	900	mW

### Thermal Resistance

Channel-soldering point 1)	R <sub>thChS</sub>	≤110	K/W

 $^{1)}T_{S}$ : Temperature at soldering point

## **Electrical Specifications:**

 $(T_A = 25^{\circ}C)$ , unless otherwise specified)

Parameter	Symbol	min	typ	max	Unit
Drain-source saturation current	/ <sub>DSS</sub>	300	450	650	mA
$V_{\text{DS}} = 3 \text{ V}$ $V_{\text{GS}} = 0 \text{ V}$					
Drain-source pinch-off current	/ <sub>D</sub>	-	5	50	μA
$V_{\text{DS}} = 3 \text{ V}$ $V_{\text{GS}} = -3.8 \text{ V}$					
Gate pinch-off current	I <sub>G</sub>	-	5	20	μA
$V_{\text{DS}} = 3 \text{ V}$ $V_{\text{GS}} = -3.8 \text{ V}$					
Pinch-off Voltage	VGS(p)	-3.8	-2.8	-1.8	V
V <sub>DS</sub> = 3 V / <sub>D</sub> =50μA	()-/				
Small Signal Gain*)	G	-	15.5	-	dB
$V_{\rm DS} = 5 \text{ V}$ $I_{\rm D} = 180 \text{ mA}$ f = 1.8 GHz					
P <sub>in</sub> = -5 dBm					
Small Signal Gain*)	G	-	14.5	-	dB
$V_{\rm DS} = 3 \text{ V}$ $I_{\rm D} = 180 \text{ mA}$ f = 1.8 GHz					
P <sub>in</sub> = -5 dBm					
Output Power	Po	22.5	23.5	-	dBm
$V_{\rm DS} = 3 \text{ V}$ $I_{\rm D} = 180 \text{ mA}$ f = 1.8 GHz					
P <sub>in</sub> = 10 dBm					

# **Electrical Specifications, Continued:**

1dB-Compression Point	P <sub>1dB</sub>	-	23.5	-	dBm
<i>V</i> <sub>DS</sub> = 3 V <i>I</i> <sub>D</sub> = 180 mA f = 1.8 GHz					
1dB-Compression Point	P <sub>1dB</sub>	-	27.0	-	dBm
<i>V</i> <sub>DS</sub> = 5 V <i>I</i> <sub>D</sub> = 180 mA f = 1.8GHz					
Power Added Efficiency	PAE	-	55	-	%
$V_{\rm DS} = 3 \text{ V}$ $I_{\rm D} = 180 \text{ mA}$ f = 1.8 GHz					
P <sub>in</sub> = 10 dBm					
Noise figure	NF		1.48		dB
V <sub>DS</sub> = 3 V <i>I</i> <sub>D</sub> = 180 mA f = 1.8GHz					

\*) Matching conditions for maximum small signal gain (not identical with power matching conditions!)

\*\*) Power matching conditions: f=1.8GHz:

Source Match:  $\Gamma_{ms}$ : MAG = 0.74, ANG 132°; Load Match:  $\Gamma_{ml}$ : ;MAG 0.61, ANG -153°

### **Electrical Characteristics, Continued:**



...<sup>...</sup>

**[V]**6

 $\rightarrow$ 

## **Output characteristics:**



÷

Drain-Source Voltage \_\_\_\_

## **Electrical Characteristics, Continued:**

	$\vee$	′DS = 3 V	I <sub>D</sub> = 180 mA			$Z_0 = 50$		
Freq. [GHz]	S11	<s11< td=""><td> S21 </td><td>&lt;\$21</td><td> S12 </td><td><s12< td=""><td> S22 </td><td>&lt;\$22</td></s12<></td></s11<>	S21	<\$21	S12	<s12< td=""><td> S22 </td><td>&lt;\$22</td></s12<>	S22	<\$22
100	0.992	-13.3	10.120	170.7	0.008	101.1	0.115	-34.6
200	0.974	-26.4	9.778	162.6	0.014	74.1	0.140	-57.5
300	0.950	-38.6	9.278	154.7	0.021	74.0	0.171	-72.3
400	0.922	-49.5	8.683	147.8	0.025	68.0	0.200	-82.0
500	0.896	-59.1	8.042	141.8	0.031	64.8	0.226	-89.1
600	0.871	-67.1	7.444	137.0	0.033	63.0	0.248	-93.8
700	0.849	-74.0	6.880	132.5	0.036	60.6	0.267	-96.9
800	0.828	-79.9	6.373	129.1	0.038	60.2	0.284	-98.8
900	0.813	-85.0	5.900	125.9	0.039	59.1	0.299	-100.1
1,000	0.800	-89.2	5.485	123.4	0.041	59.5	0.312	-100.4
1,100	0.790	-92.6	5.110	121.3	0.041	59.4	0.323	-100.5
1,200	0.780	-95.5	4.780	119.3	0.043	60.2	0.335	-100.0
1,300	0.773	-97.7	4.498	117.7	0.043	61.6	0.345	-99.3
1,400	0.766	-99.6	4.225	116.2	0.044	62.3	0.354	-98.2
1,500	0.760	-100.9	3.987	115.3	0.045	64.1	0.364	-97.1
1,600	0.754	-102.0	3.769	114.4	0.045	65.9	0.372	-95.7
1,700	0.751	-102.7	3.588	113.6	0.045	67.7	0.380	-94.3
1,800	0.748	-103.3	3.426	112.9	0.046	70.0	0.388	-92.6
1,900	0.743	-103.5	3.268	112.3	0.046	71.8	0.397	-90.9
2,000	0.741	-103.8	3.119	111.7	0.047	74.525	0.404	-89.2

#### Typical Common Source S-Parameters and noise data $\sqrt{2} = 2 \sqrt{2} = 120 \text{ m}^{3}$

f	F <sub>min</sub>	$\Gamma_{\sf opt}$		R <sub>n</sub>	r <sub>n</sub>
GHz	dB	MAG	ANG	Ω	-
0.9	0.79	0.564	61	13.4	0.267
1.8	1.47	0.585	99	13.6	0.272

Additional S-Parameter and noise data available on data disc!

## **Electrical Characteristics, Continued:**

## **Total Power Dissipation**



## Permissible Pulse Load



## Package Dimensions:



1st angle Projection

Dim.	min.	nom.	max.	Gradient	Remark
А			1.1		
A <sub>1</sub>			0.1		
A <sub>2</sub>			1.0		
b		0.3			
b <sub>1</sub>		0.6			
С	0.08		0.15		
D	2.8		3.0		
E	1.2		1.4		
e		0.95			
e <sub>1</sub>		1.9			
H <sub>F</sub>			2.6		
L <sub>F</sub>			0.6		
а				max 10°	1
q				2°30°	

- 1. MSL Rating: 1/260C
- 2. Pb Free

### **Package Marking:**



Package Orientation on Reel:

6	Ŭ	Ē	$\bar{\oplus}$	Ť	₽	ŵ	
1	30	30	30	3	30	36	A C
SC	T23	-6 8 scn	8, 1	WW-	6 8	SCT	-598

# **Ordering Information:**

Туре	Marking		Pin Configuration					Package 1)
	-	. 1	2	3	4	5	6	
CLY 2	CY2	G	S	D	D	S	G	MW 6

ESD: Electrostatic discharge sensitive device, observe handling precautions!

### Additional Information

For latest specifications, additional product information, worldwide sales and distribution locations, and information about TriQuint:

Web: www.triquint.com	Tel: (503) 615-9000
Email: info_wireless@tqs.com	Fax: (503) 615-8902

For technical questions and additional information on specific applications:

#### Email: info\_wireless@tqs.com

The information provided herein is believed to be reliable; TriQuint assumes no liability for inaccuracies or omissions. TriQuint assumes no responsibility for the use of this information, and all such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party.

TriQuint does not authorize or warrant any TriQuint product for use in life-support devices and/or systems.

Copyright © 2004TriQuint Semiconductor, Inc. All rights reserved.

Revision 1.8 March 4, 2004



This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

 $\frac{\text{TriQuint:}}{\frac{\text{CLY2}}{2}}$